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### What is "[Embedded - Microcontrollers](#)"?

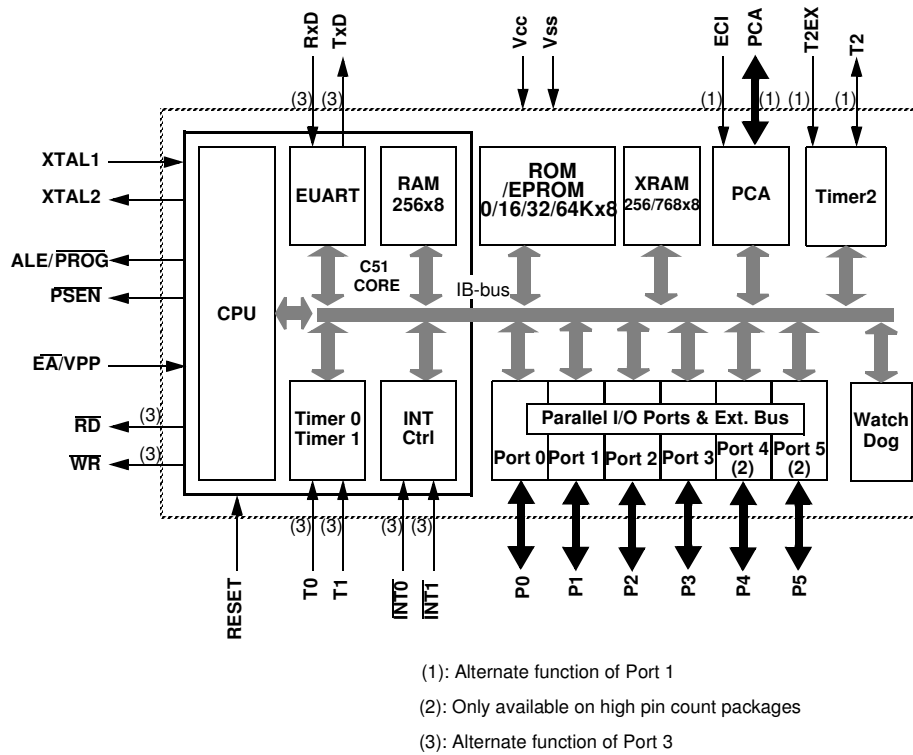
"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	30/20MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	32
Program Memory Size	64KB (64K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.6x16.6)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/at87c51rd2-slsul">https://www.e-xfl.com/product-detail/microchip-technology/at87c51rd2-slsul</a>

### 3. Block Diagram



Mnemonic	Pin Number			Type	Name And Function
	DIL	LCC	VQFP 1.4		
V <sub>SS</sub>	20	22	16	I	<b>Ground:</b> 0V reference
V <sub>SS1</sub>		1	39	I	Optional Ground: <b>Contact the Sales Office for ground connection.</b>
V <sub>CC</sub>	40	44	38	I	<b>Power Supply:</b> This is the power supply voltage for normal, idle and power-down operation
P0.0-P0.7	39-32	43-36	37-30	I/O	<b>Port 0:</b> Port 0 is an open-drain, bidirectional I/O port. Port 0 pins that have 1s written to them float and can be used as high impedance inputs. Port 0 pins must be polarized to V <sub>CC</sub> or V <sub>SS</sub> in order to prevent any parasitic current consumption. Port 0 is also the multiplexed low-order address and data bus during access to external program and data memory. In this application, it uses strong internal pull-up when emitting 1s. Port 0 also inputs the code bytes during EPROM programming. External pull-ups are required during program verification during which P0 outputs the code bytes.
P1.0-P1.7	1-8	2-9	40-44 1-3	I/O	<b>Port 1:</b> Port 1 is an 8-bit bidirectional I/O port with internal pull-ups. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 1 pins that are externally pulled low will source current because of the internal pull-ups. Port 1 also receives the low-order address byte during memory programming and verification. Alternate functions for Port 1 include:
	1	2	40	I/O	<b>T2 (P1.0):</b> Timer/Counter 2 external count input/Clockout
	2	3	41	I	<b>T2EX (P1.1):</b> Timer/Counter 2 Reload/Capture/Direction Control
	3	4	42	I	<b>ECI (P1.2):</b> External Clock for the PCA
	4	5	43	I/O	<b>CEX0 (P1.3):</b> Capture/Compare External I/O for PCA module 0
	5	6	44	I/O	<b>CEX1 (P1.4):</b> Capture/Compare External I/O for PCA module 1
	6	7	45	I/O	<b>CEX0 (P1.5):</b> Capture/Compare External I/O for PCA module 2
	7	8	46	I/O	<b>CEX0 (P1.6):</b> Capture/Compare External I/O for PCA module 3
	8	9	47	I/O	<b>CEX0 (P1.7):</b> Capture/Compare External I/O for PCA module 4
P2.0-P2.7	21-28	24-31	18-25	I/O	<b>Port 2:</b> Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 2 pins that are externally pulled low will source current because of the internal pull-ups. Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX @Ri), port 2 emits the contents of the P2 SFR. Some Port 2 pins (P2.0 to P2.5) receive the high order address bits during EPROM programming and verification:
P3.0-P3.7	10-17	11, 13-19	5, 7-13	I/O	<b>Port 3:</b> Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally pulled low will source current because of the internal pull-ups. Some Port 3 pins (P3.4 to P3.5) receive the high order address bits during EPROM programming and verification. Port 3 also serves the special features of the 80C51 family, as listed below.
	10	11	5	I	<b>RXD (P3.0):</b> Serial input port
	11	13	7	O	<b>TXD (P3.1):</b> Serial output port

## 6. Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.

### ASSEMBLY LANGUAGE

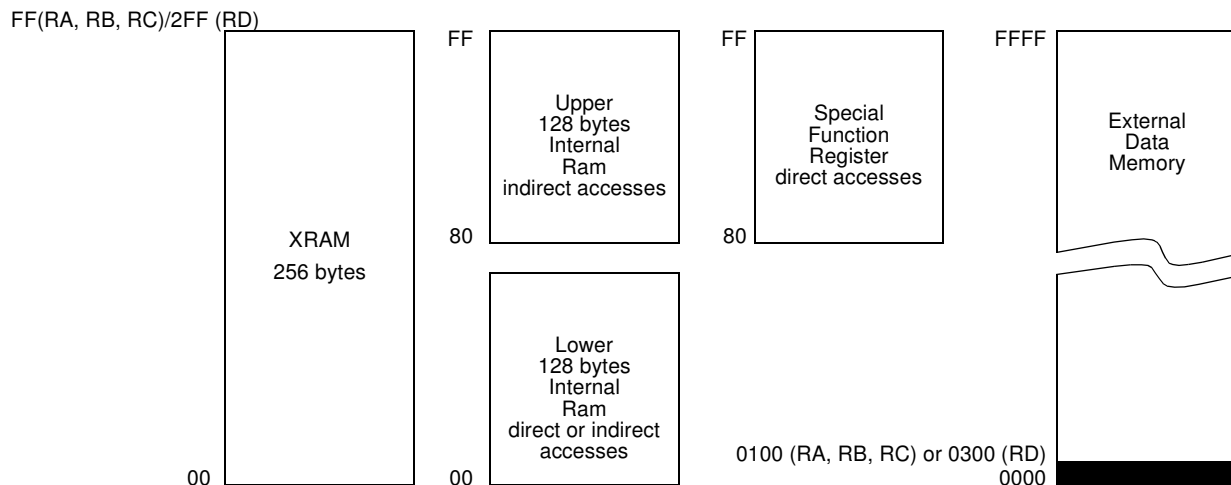
```
; Block move using dual data pointers
; Destroys DPTR0, DPTR1, A and PSW
; note: DPS exits opposite of entry state
; unless an extra INC AUXR1 is added
;
00A2  AUXR1 EQU 0A2H
;
0000 909000MOV DPTR,#SOURCE ; address of SOURCE
0003 05A2 INC AUXR1 ; switch data pointers
0005 90A000 MOV DPTR,#DEST ; address of DEST
0008 LOOP:
0008 05A2 INC AUXR1 ; switch data pointers
000A E0 MOVX A,@DPTR ; get a byte from SOURCE
000B A3 INC DPTR ; increment SOURCE address
000C 05A2 INC AUXR1 ; switch data pointers
000E F0 MOVX @DPTR,A ; write the byte to DEST
000F A3 INC DPTR ; increment DEST address
0010 70F6JNZ LOOP ; check for 0 terminator
0012 05A2 INC AUXR1 ; (optional) restore DPS
```

INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.

address bits (DPL) with data. MOVX @ Ri and MOVX @DPTR will generate either read or write signals on P3.6 ( $\overline{WR}$ ) and P3.7 ( $\overline{RD}$ ).

The stack pointer (SP) may be located anywhere in the 256 bytes RAM (lower and upper RAM) internal data memory. The stack may not be located in the XRAM.

**Figure 6-1.** Internal and External Data Memory Address



**Table 6-1.** Auxiliary Register AUXR

AUXR Address 08EH		-	-	-	-	-	-	EXTRAM	AO
Reset value		X	X	X	X	X	X	0	0

Symbol	Function	
-	Not implemented, reserved for future use. <sup>(1)</sup>	
AO	Disable/Enable ALE	
	AO	Operating Mode
	0	ALE is emitted at a constant rate of 1/6 the oscillator frequency (or 1/3 if X2 mode is used)
	1	ALE is active only during a MOVX or MOVC instruction
EXTRAM	Internal/External RAM (00H-FFH) access using MOVX @ Ri/ @ DPTR	
	EXTRAM	Operating Mode
	0	Internal XRAM access using MOVX @ Ri/ @ DPTR
	1	External data memory access

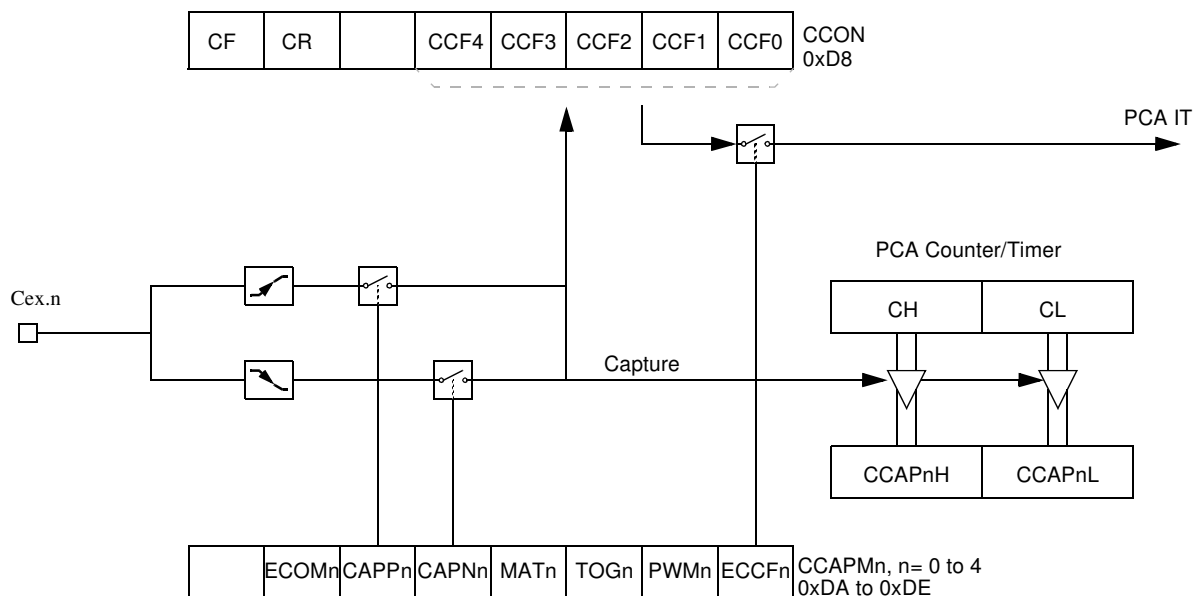
1. User software should not write 1s to reserved bits. These bits may be used in future 8051 family products to invoke new features. In that case, the reset or inactive value of the new bit will be 0, and its active value will be 1. The value read from a reserved bit is indeterminate.

Bit Number	Bit Mnemonic	Description
7	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
6	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
5	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
4	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
3	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
2	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.
1	T2OE	<b>Timer 2 Output Enable bit</b> Clear to program P1.0/T2 as clock input or I/O port. Set to program P1.0/T2 as clock output.
0	DCEN	<b>Down Counter Enable bit</b> Clear to disable timer 2 as up/down counter. Set to enable timer 2 as up/down counter.

Reset Value = XXXX XX00b

Not bit addressable

**Figure 6-6. PCA Capture Mode**



### 6.3.2 16-bit Software Timer/ Compare Mode

The PCA modules can be used as software timers by setting both the **ECOM** and **MAT** bits in the modules **CCAPMn** register. The PCA timer will be compared to the module's capture registers and when a match occurs an interrupt will occur if the **CCFn** (**CCON** SFR) and the **ECCFn** (**CCAPMn** SFR) bits for the module are both set (See Figure 6-7).

```
Slave C:SADDR1111 0010b
      SADEN1111 1101b
Given1111 00X1b
```

The SADEN byte is selected so that each slave may be addressed separately.

For slave A, bit 0 (the LSB) is a don't-care bit; for slaves B and C, bit 0 is a 1. To communicate with slave A only, the master must send an address where bit 0 is clear (e.g. 1111 0000b).

For slave A, bit 1 is a 1; for slaves B and C, bit 1 is a don't care bit. To communicate with slaves B and C, but not slave A, the master must send an address with bits 0 and 1 both set (e.g. 1111 0011b).

To communicate with slaves A, B and C, the master must send an address with bit 0 set, bit 1 clear, and bit 2 clear (e.g. 1111 0001b).

#### 6.4.4 Broadcast Address

A broadcast address is formed from the logical OR of the SADDR and SADEN registers with zeros defined as don't-care bits, e.g.:

```
SADDR0101 0110b
SADEN1111 1100b
Broadcast =SADDR OR SADEN1111 111Xb
```

The use of don't-care bits provides flexibility in defining the broadcast address, however in most applications, a broadcast address is FFh. The following is an example of using broadcast addresses:

```
Slave A:SADDR1111 0001b
      SADEN1111 1010b
Broadcast1111 1X11b,
```

```
Slave B:SADDR1111 0011b
      SADEN1111 1001b
Broadcast1111 1X11B,
```

```
Slave C:SADDR=1111 0010b
      SADEN1111 1101b
Broadcast1111 1111b
```

For slaves A and B, bit 2 is a don't care bit; for slave C, bit 2 is set. To communicate with all of the slaves, the master must send an address FFh. To communicate with slaves A and B, but not slave C, the master can send an address FBh.

#### 6.4.5 Reset Addresses

On reset, the SADDR and SADEN registers are initialized to 00h, i.e. the given and broadcast addresses are XXXX XXXXb (all don't-care bits). This ensures that the serial port will reply to any address, and so, that it is backwards compatible with the 80C51 microcontrollers that do not support automatic address recognition.



**Table 6-19.** IPH Register  
IPH - Interrupt Priority High Register (B7h)

7	6	5	4	3	2	1	0
-	PPCH	PT2H	PSH	PT1H	PX1H	PT0H	PX0H
Bit Number	Bit Mnemonic	Description					
7	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.					
6	PPCH	PCA interrupt priority bit high. <u>PPCH</u> <u>PPC</u> <u>Priority Level</u> 0 0      Lowest 0 1 1 0 1 1 Highest					
5	PT2H	Timer 2 overflow interrupt Priority High bit <u>PT2H</u> <u>PT2</u> <u>Priority Level</u> 0 0      Lowest 0 1 1 0 1 1 Highest					
4	PSH	Serial port Priority High bit <u>PSH</u> <u>PS</u> <u>Priority Level</u> 0 0Lowest 0 1 1 0 1 1Highest					
3	PT1H	Timer 1 overflow interrupt Priority High bit <u>PT1H</u> <u>PT1</u> <u>Priority Level</u> 0 0Lowest 0 1 1 0 1 1Highest					
2	PX1H	External interrupt 1 Priority High bit <u>PX1H</u> <u>PX1</u> <u>Priority Level</u> 0 0Lowest 0 1 1 0 1 1Highest					
1	PT0H	Timer 0 overflow interrupt Priority High bit <u>PT0H</u> <u>PT0</u> <u>Priority Level</u> 0 0      Lowest 0 1 1 0 1 1      Highest					
0	PX0H	External interrupt 0 Priority High bit <u>PX0H</u> <u>PX0</u> <u>Priority Level</u> 0 0      Lowest 0 1 1 0 1 1      Highest					

Reset Value = X000 0000b

Not bit addressable

#### 8.2.4 Verify Algorithm

Refer to Section “Verify algorithm”.

WARNING: Security level 2 and 3 should only be programmed after EPROM and Core verification.

### 9.2.3 Signature bytes

The TS87C51RB2/RC2/RD2 contains 4 factory programmed signature bytes. To read these bytes, perform the process described in Section “Signature bytes”.

## 9.3 EPROM Programming

### 9.3.1 Set-up Modes

In order to program and verify the EPROM or to read the signature bytes, the TS87C51RB2/RC2/RD2 is placed in specific set-up modes (See Figure 9-1.).

Control and program signals must be held at the levels indicated in Table 9-2.

### 9.3.2 Definition of Terms








**Address Lines:**P1.0-P1.7, P2.0-P2.5, P3.4, P3.5 respectively for A0-A15 (P2.5 (A13) for RB, P3.4 (A14) for RC, P3.5 (A15) for RD)

**Data Lines:**P0.0-P0.7 for D0-D7

**Control Signals:**RST,  $\overline{\text{PSEN}}$ , P2.6, P2.7, P3.3, P3.6, P3.7.

**Program Signals:**ALE/ $\overline{\text{PROG}}$ ,  $\overline{\text{EA}}$ /VPP.

**Table 9-2.** EPROM Set-Up Modes

Mode	RST	PSEN	ALE/ $\overline{\text{P}}\overline{\text{ROG}}$	$\overline{\text{EA}}$ /VP P	P2.6	P2.7	P3.3	P3.6	P3.7
Program Code data	1	0		12.75V	0	1	1	1	1
Verify Code data	1	0	1	1	0		0	1	1
Program Encryption Array Address 0-3Fh	1	0		12.75V	0	1	1	0	1
Read Signature Bytes	1	0	1	1	0		0	0	0
Program Lock bit 1	1	0		12.75V	1	1	1	1	1
Program Lock bit 2	1	0		12.75V	1	1	1	0	0
Program Lock bit 3	1	0		12.75V	1	0	1	1	0

60h	FCh	Product name: TS87C51RD2
60h	37h	Product name: TS83C51RC2
60h	B7h	Product name: TS87C51RC2
60h	3Bh	Product name: TS83C51RB2
60h	BBh	Product name: TS87C51RB2
61h	FFh	Product revision number

## 11.5.4 External Data Memory Characteristics

Symbol	Parameter
$T_{RLRH}$	$\overline{RD}$ Pulse Width
$T_{WLWH}$	$\overline{WR}$ Pulse Width
$T_{RLDV}$	$\overline{RD}$ to Valid Data In
$T_{RHDx}$	Data Hold After $\overline{RD}$
$T_{RHDZ}$	Data Float After $\overline{RD}$
$T_{LLDV}$	ALE to Valid Data In
$T_{AVDV}$	Address to Valid Data In
$T_{LLWL}$	ALE to $\overline{WR}$ or $\overline{RD}$
$T_{AVWL}$	Address to $\overline{WR}$ or $\overline{RD}$
$T_{QVWX}$	Data Valid to $\overline{WR}$ Transition
$T_{QVWH}$	Data set-up to $\overline{WR}$ High
$T_{WHQX}$	Data Hold After $\overline{WR}$
$T_{RLAZ}$	$\overline{RD}$ Low to Address Float
$T_{WHLH}$	$\overline{RD}$ or $\overline{WR}$ High to ALE high

**Table 11-8.** AC Parameters for a Fix Clock

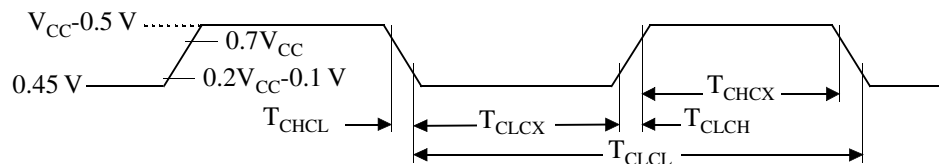
Speed	-M 40 MHz		-V X2 mode 30 MHz 60 MHz equiv.		-V standard mode 40 MHz		-L X2 mode 20 MHz 40 MHz equiv.		-L standard mode 30 MHz		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
$T_{RLRH}$	130		85		135		125		175		ns
$T_{WLWH}$	130		85		135		125		175		ns
$T_{RLDV}$		100		60		102		95		137	ns
$T_{RHDx}$	0		0		0		0		0		ns
$T_{RHDZ}$		30		18		35		25		42	ns
$T_{LLDV}$		160		98		165		155		222	ns
$T_{AVDV}$		165		100		175		160		235	ns
$T_{LLWL}$	50	100	30	70	55	95	45	105	70	130	ns
$T_{AVWL}$	75		47		80		70		103		ns
$T_{QVWX}$	10		7		15		5		13		ns
$T_{QVWH}$	160		107		165		155		213		ns
$T_{WHQX}$	15		9		17		10		18		ns
$T_{RLAZ}$		0		0		0		0		0	ns
$T_{WHLH}$	10	40	7	27	15	35	5	45	13	53	ns

### 11.5.11 External Clock Drive Characteristics (XTAL1)

Symbol	Parameter	Min	Max	Units
$T_{CLCL}$	Oscillator Period	25		ns
$T_{CHCX}$	High Time	5		ns
$T_{CLCX}$	Low Time	5		ns
$T_{CLCH}$	Rise Time		5	ns
$T_{CHCL}$	Fall Time		5	ns
$T_{CHCX}/T_{CLCX}$	Cyclic ratio in X2 mode	40	60	%

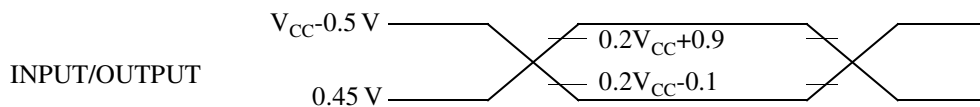
### 11.5.12 External Clock Drive Waveforms

Figure 11-11. External Clock Drive Waveforms



### 11.5.13 AC Testing Input/Output Waveforms

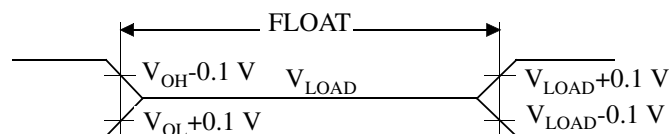
Figure 11-12. AC Testing Input/Output Waveforms



AC inputs during testing are driven at  $V_{CC} - 0.5$  for a logic "1" and 0.45V for a logic "0". Timing measurement are made at  $V_{IH}$  min for a logic "1" and  $V_{IL}$  max for a logic "0".

### 11.5.14 Float Waveforms

Figure 11-13. Float Waveforms



For timing purposes a port pin is no longer floating when a 100 mV change from load voltage occurs and begins to float when a 100 mV change from the loaded  $V_{OH}/V_{OL}$  level occurs.  $I_{OL}/I_{OH} \geq \pm 20mA$ .

## 12. Ordering Information

Part Number	Memory size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
TS80C51RA2-MCA	OBSOLETE					
TS80C51RA2-MCB						
TS80C51RA2-MCE						
TS80C51RA2-MIA						
TS80C51RA2-MIB						
TS80C51RA2-MIE						
TS80C51RA2-LCA						
TS80C51RA2-LCB						
TS80C51RA2-LCE						
TS80C51RA2-LIA						
TS80C51RA2-LIB						
TS80C51RA2-LIE						
TS80C51RA2-VCA						
TS80C51RA2-VCB						
TS80C51RA2-VCE						
TS80C51RA2-VIA						
TS80C51RA2-VIB						
TS80C51RA2-VIE						
AT80C51RA2-3CSUM	Romless	5V	Industrial & Green	40 MHz (20 MHz X2)	PDIL40	Stick
AT80C51RA2-SLSUM	Romless	5V	Industrial & Green	40 MHz (20 MHz X2)	PLCC44	Stick
AT80C51RA2-RLTUM	Romless	5V	Industrial & Green	40 MHz (20 MHz X2)	VQFP44	Tray
AT80C51RA2-3CSIM	OBSOLETE					
AT80C51RA2-SLSIM						
AT80C51RA2-RLTIM						
AT80C51RA2-3CSCL						
AT80C51RA2-SLSCL						
AT80C51RA2-RLTCL						
AT80C51RA2-3CSUL	Romless	3-5V	Industrial & Green	30 MHz (20 MHz X2)	PDIL40	Stick
AT80C51RA2-SLSUL	Romless	3-5V	Industrial & Green	30 MHz (20 MHz X2)	PLCC44	Stick
AT80C51RA2-RLTUL	Romless	3-5V	Industrial & Green	30 MHz (20 MHz X2)	VQFP44	Tray

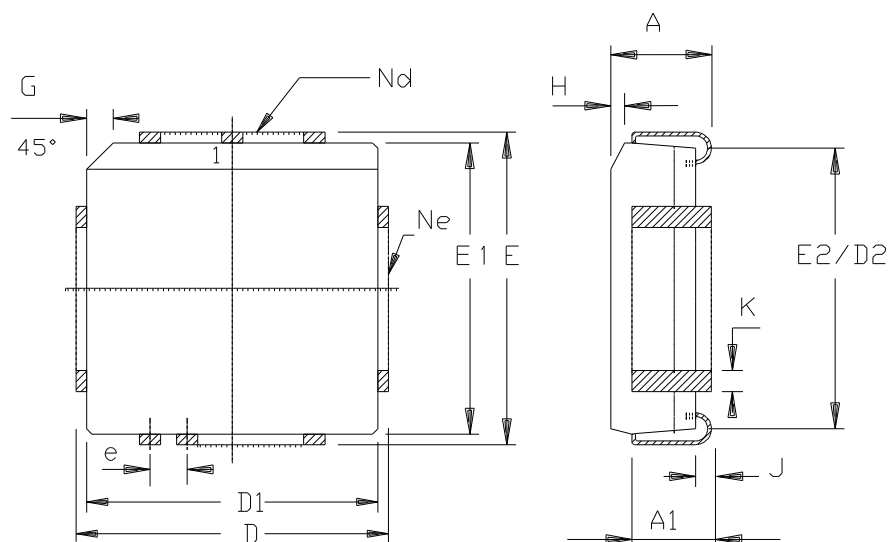
Part Number	Memory size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
AT80C51RA2-3CSCV	OBSOLETE					
AT80C51RA2-SLSCV						
AT80C51RA2-RLTCV						
AT80C51RA2-3CSIV						
AT80C51RA2-SLSIV						
AT80C51RA2-RLSIV						
TS80C51RD2-MCA	Not recommended use AT87C51RD2					
TS80C51RD2-MCB	Not recommended use AT87C51RD2					
TS80C51RD2-MCE	Not recommended use AT87C51RD2					
TS80C51RD2-MIA	Not recommended use AT87C51RD2					
TS80C51RD2-MIB	Not recommended use AT87C51RD2					
TS80C51RD2-MIE	Not recommended use AT87C51RD2					
TS80C51RD2-LCA	Not recommended use AT87C51RD2					
TS80C51RD2-LCB	Not recommended use AT87C51RD2					
TS80C51RD2-LCE	Not recommended use AT87C51RD2					
TS80C51RD2-LIA	Not recommended use AT87C51RD2					
TS80C51RD2-LIB	Not recommended use AT87C51RD2					
TS80C51RD2-LIE	Not recommended use AT87C51RD2					
TS80C51RD2-VCA	Not recommended use AT87C51RD2					
TS80C51RD2-VCB	Not recommended use AT87C51RD2					
TS80C51RD2-VCE	Not recommended use AT87C51RD2					
TS80C51RD2-VIA	Not recommended use AT87C51RD2					
TS80C51RD2-VIB	Not recommended use AT87C51RD2					
TS80C51RD2-VIE	Not recommended use AT87C51RD2					
AT80C51RD2-3CSUM	Not recommended use AT87C51RD2					
AT80C51RD2-SLSUM	Not recommended use AT87C51RD2					
AT80C51RD2-RLTUM	Not recommended use AT87C51RD2					
AT80C51RD2-3CSUL	Not recommended use AT87C51RD2					
AT80C51RD2-SLSUL	Not recommended use AT87C51RD2					
AT80C51RD2-RLTUL	Not recommended use AT87C51RD2					



Part Number	Memory size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
TS87C51RD2-MCA	OBSOLETE					
TS87C51RD2-MCB						
TS87C51RD2-MCE						
TS87C51RD2-MIA						
TS87C51RD2-MIB						
TS87C51RD2-MIE						
TS87C51RD2-LCA						
TS87C51RD2-LCB						
TS87C51RD2-LCE						
TS87C51RD2-LIA						
TS87C51RD2-LIB						
TS87C51RD2-LIE						
TS87C51RD2-VCA						
TS87C51RD2-VCB						
TS87C51RD2-VCE						
TS87C51RD2-VCL						
TS87C51RD2-VIA						
TS87C51RD2-VIB						
TS87C51RD2-VIE						
AT87C51RD2-3CSUM	OTP 64k Bytes	5V	Industrial & Green	40 MHz (20 MHz X2)	PDIL40	Stick
AT87C51RD2-SLSUM	OTP 64k Bytes	5V	Industrial & Green	40 MHz (20 MHz X2)	PLCC44	Stick
AT87C51RD2-RLTUM	OTP 64k Bytes	5V	Industrial & Green	40 MHz (20 MHz X2)	VQFP44	Tray
AT87C51RD2-3CSUL	OTP 64k Bytes	3-5V	Industrial & Green	30 MHz (20 MHz X2)	PDIL40	Stick
AT87C51RD2-SLSUL	OTP 64k Bytes	3-5V	Industrial & Green	30 MHz (20 MHz X2)	PLCC44	Stick
AT87C51RD2-RLTUL	OTP 64k Bytes	3-5V	Industrial & Green	30 MHz (20 MHz X2)	VQFP44	Tray

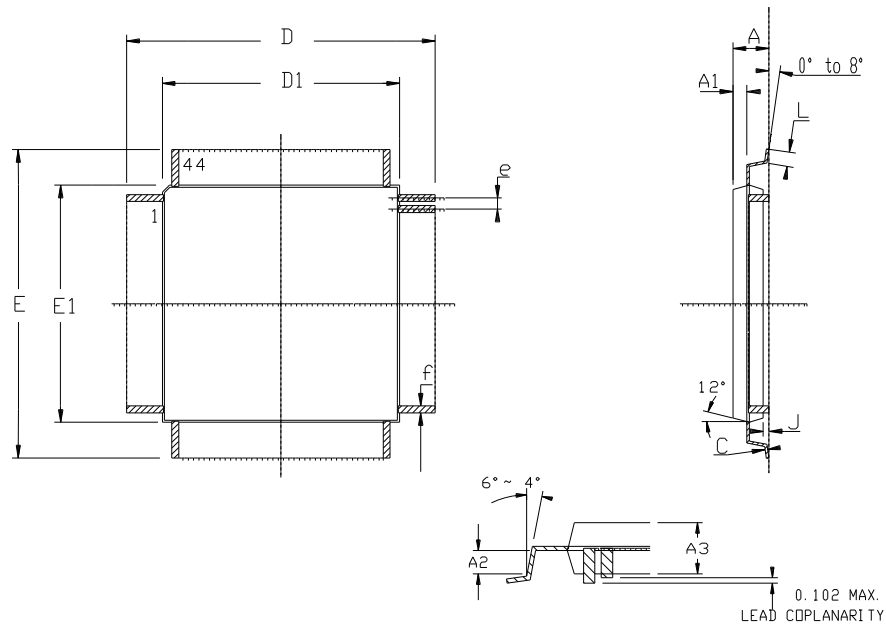
## 13. Package Drawings

### 13.1 PLCC44



	MM		INCH	
A	4.20	4.57	.165	.180
A1	2.29	3.04	.090	.120
D	17.40	17.65	.685	.695
D1	16.44	16.66	.647	.656
D2	14.99	16.00	.590	.630
E	17.40	17.65	.685	.695
E1	16.44	16.66	.647	.656
E2	14.99	16.00	.590	.630
e	1.27	BSC	.050	BSC
G	1.07	1.22	.042	.048
H	1.07	1.42	.042	.056
J	0.51	-	.020	-
K	0.33	0.53	.013	.021
Nd	11		11	
Ne	11		11	
PKG STD	00			

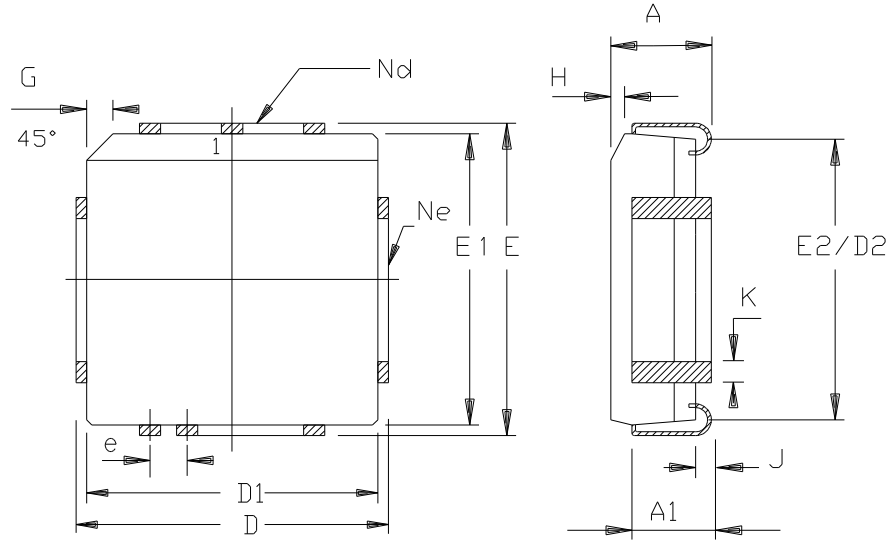
### 13.3 VQFP44



	MM		INCH	
	Min	Max	Min	Max
A	-	1.60	-	.063
A1	0.64 REF		.025 REF	
A2	0.64 REF		.025 REF	
A3	1.35	1.45	.053	.057
D	11.90	12.10	.468	.476
D1	9.90	10.10	.390	.398
E	11.90	12.10	.468	.476
E1	9.90	10.10	.390	.398
J	0.05	-	.002	-
L	0.45	0.75	.018	.030
e	0.80 BSC		.0315 BSC	
f	0.35 BSC		.014 BSC	

## 13.5 PLCC68

68 PINS PLCC



	MM		INCH	
A	4.20	5.08	.165	.200
A1	2.29	3.30	.090	.130
D	25.02	25.27	.985	.995
D1	24.13	24.33	.950	.958
D2	22.61	23.62	.890	.930
E	25.02	25.27	.985	.995
E1	24.13	24.33	.950	.958
E2	22.61	23.62	.890	.930
e	1.27	BSC	.050	BSC
G	1.07	1.22	.042	.048
H	1.07	1.42	.042	.056
J	0.51	-	.020	-
K	0.33	0.53	.013	.021
Nd	17		17	
Ne	17		17	
PKG STD	00			

## 14. Datasheet Revision History

### 14.1 Changes from 4188E to 4188F

1. Removed TS80C51RD2 and AT80C51RD2 from “Ordering Information” on page 73.
2. Removed non-green part numbers from ordering information.



## Headquarters

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**Atmel Corporation**  
2325 Orchard Parkway  
San Jose, CA 95131  
USA  
Tel: 1(408) 441-0311  
Fax: 1(408) 487-2600

## International

---

**Atmel Asia**  
Room 1219  
Chinachem Golden Plaza  
77 Mody Road Tsimshatsui  
East Kowloon  
Hong Kong  
Tel: (852) 2721-9778  
Fax: (852) 2722-1369

**Atmel Europe**  
Le Krebs  
8, Rue Jean-Pierre Timbaud  
BP 309  
78054 Saint-Quentin-en-  
Yvelines Cedex  
France  
Tel: (33) 1-30-60-70-00  
Fax: (33) 1-30-60-71-11

**Atmel Japan**  
9F, Tonetsu Shinkawa Bldg.  
1-24-8 Shinkawa  
Chuo-ku, Tokyo 104-0033  
Japan  
Tel: (81) 3-3523-3551  
Fax: (81) 3-3523-7581

## Product Contact

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